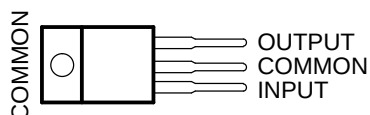


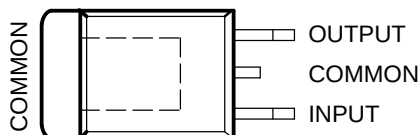
FEATURES

- 3-Terminal Regulators
- Output Current up to 500 mA
- No External Components
- Internal Thermal-Overload Protection
- High Power-Dissipation Capability
- Internal Short-Circuit Current Limiting
- Output Transistor Safe-Area Compensation

**KC (TO-220) PACKAGE
(TOP VIEW)**

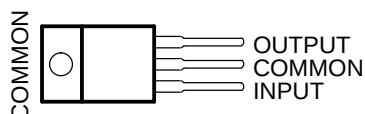


**KTP (PowerFLEX™/TO-252*) PACKAGE
(TOP VIEW)**

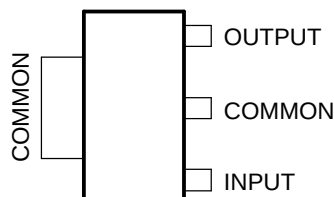


* Complies with JEDEC TO-252, variation AC

**KCS (TO-220) PACKAGE
(TOP VIEW)**



**DCY (SOT-223) PACKAGE
(TOP VIEW)**



DESCRIPTION/ORDERING INFORMATION

This series of fixed-voltage integrated-circuit voltage regulators is designed for a wide range of applications. These applications include on-card regulation for elimination of noise and distribution problems associated with single-point regulation. Each of these regulators can deliver up to 500 mA of output current. The internal current-limiting and thermal-shutdown features of these regulators essentially make them immune to overload. In addition to use as fixed-voltage regulators, these devices can be used with external components to obtain adjustable output voltages and currents and also as the power-pass element in precision regulators.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PowerFLEX, PowerPAD are trademarks of Texas Instruments.

μA78M00 SERIES
POSITIVE-VOLTAGE REGULATORS

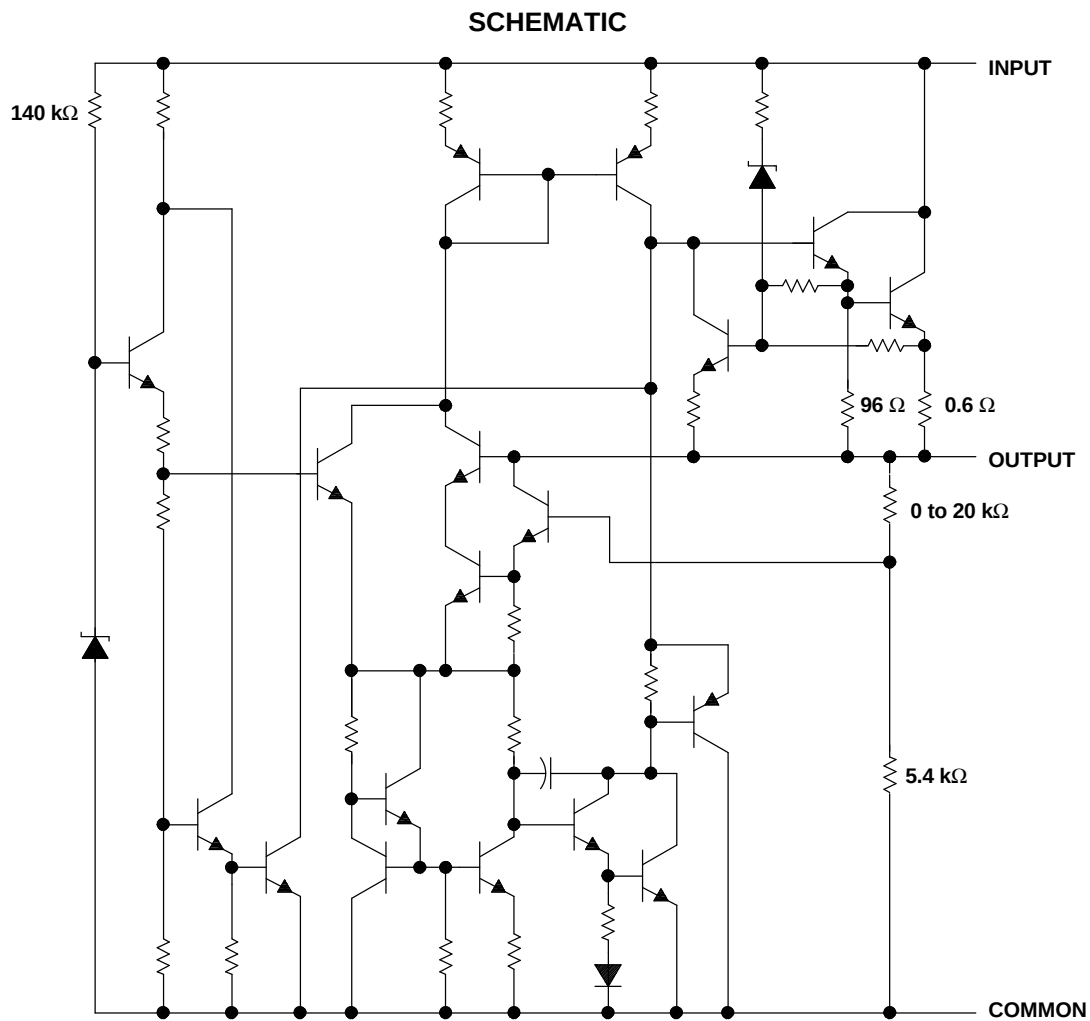
SLVS059P–JUNE 1976–REVISED OCTOBER 2005

ORDERING INFORMATION

T _A	V _{O(NOM)} (V)	PACKAGE ⁽¹⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 125°C	3.3	PowerFLEX™/TO-252 ⁽²⁾ – KTP	Reel of 3000	μA78M33CKTPR	UA78M33C
		SOT-223 – DCY	Tube of 80	μA78M33CDCY	C3
			Reel of 2500	μA78M33CDCYR	
		TO-220 – KC	Tube of 50	μA78M33CKC	UA78M33C
	5	PowerFLEX/TO-252 ⁽²⁾ – KTP	Reel of 3000	μA78M05CKTPR	UA78M05C
		SOT-223 – DCY	Tube of 80	μA78M05CDCY	C5
			Reel of 2500	μA78M05CDCYR	
		TO-220 – KC	Tube of 50	μA78M05CKC	UA78M05C
		TO-220, short shoulder – KCS	Tube of 20	μA78M05CKCS	
	6	PowerFLEX/TO-252 ⁽²⁾ – KTP	Reel of 3000	μA78M06CKTPR	UA78M06C
	8	PowerFLEX/TO-252 ⁽²⁾ – KTP	Reel of 3000	μA78M08CKTPR	UA78M08C
		SOT-223 – DCY	Tube of 80	μA78M08CDCY	C8
			Reel of 2500	μA78M08CDCYR	
		TO-220 – KC	Tube of 50	μA78M08CKC	UA78M08C
	9	PowerFLEX/TO-252 ⁽²⁾ – KTP	Reel of 3000	μA78M09CKTPR	UA78M09C
	10	PowerFLEX/TO-252 ⁽²⁾ – KTP	Reel of 3000	μA78M10CKTPR	UA78M10C
	12	PowerFLEX/TO-252 ⁽²⁾ – KTP	Reel of 3000	μA78M12CKTPR	UA78M12C
		TO-220 – KC	Tube of 50	μA78M12CKC	UA78M12C
–40°C to 125°C	5	PowerFLEX/TO-252 ⁽²⁾ – KTP	Reel of 3000	μA78M05IKTPR	UA78M05I
		SOT-223 – DCY	Tube of 80	μA78M05IDCY	J5
			Reel of 2500	μA78M05IDCYR	
		TO-220 – KC	Tube of 50	μA78M05IKC	UA78M05I
		TO-220, short shoulder – KCS	Tube of 20	μA78M05IKCS	

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

(2) Complies with JEDEC TO-252, variation AC



Resistor values shown are nominal.

μA78M00 SERIES **POSITIVE-VOLTAGE REGULATORS**

SLVS059P–JUNE 1976–REVISED OCTOBER 2005

Absolute Maximum Ratings⁽¹⁾

over virtual junction temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V_I	Input voltage		35	V
T_J	Operating virtual junction temperature		150	°C
T_{stg}	Storage temperature range	–65	150	°C

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

Package Thermal Data⁽¹⁾

PACKAGE	BOARD	$\theta_{JP}^{(2)}$	θ_{JC}	θ_{JA}
PowerFLEX/TO-252 – KTP	High K, JESD 51-5	1.4°C/W	19°C/W	28°C/W
SOT-223 – DCY	High K, JESD 51-7		30.6°C/W	53°C/W
TO-220 – KC/KCS	High K, JESD 51-5	3°C/W	17°C/W	19°C/W

- (1) Maximum power dissipation is a function of $T_J(\text{max})$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(\text{max}) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
(2) For packages with exposed thermal pads, such as QFN, PowerPAD™, or PowerFLEX, θ_{JP} is defined as the thermal resistance between the die junction and the bottom of the exposed pad.

Recommended Operating Conditions

		MIN	MAX	UNIT
V_I	Input voltage	μA78M33	5.3	25
		μA78M05	7	25
		μA78M06	8	25
		μA78M08	10.5	25
		μA78M09	11.5	26
		μA78M10	12.5	28
		μA78M12	14.5	30
		μA78M15	17.5	30
I_O	Output current		500	mA
T_J	Operating virtual junction temperature	μA78MxxC	0	125
		μA78MxxI	–40	125

Electrical Characteristics

at specified virtual junction temperature, $V_I = 8\text{ V}$, $I_O = 350\text{ mA}$, $T_J = 25^\circ\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS ⁽¹⁾		μA78M33C			UNIT
			MIN	TYP	MAX	
Output voltage ⁽²⁾	$I_O = 5\text{ mA to }350\text{ mA}$, $V_I = 8\text{ V to }20\text{ V}$		3.2	3.3	3.4	V
		$T_J = 0^\circ\text{C to }125^\circ\text{C}$	3.1	3.3	3.5	
Input voltage regulation	$I_O = 200\text{ mA}$	$V_I = 5.3\text{ V to }25\text{ V}$		9	100	mV
		$V_I = 8\text{ V to }25\text{ V}$		3	50	
Ripple rejection	$V_I = 8\text{ V to }18\text{ V}$, $f = 120\text{ Hz}$	$I_O = 100\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$	62			dB
		$I_O = 300\text{ mA}$	62	80		
Output voltage regulation	$V_I = 8\text{ V}$	$I_O = 5\text{ mA to }500\text{ mA}$		20	100	mV
Temperature coefficient of output voltage	$I_O = 5\text{ mA}$	$T_J = 0^\circ\text{C to }125^\circ\text{C}$		–1		mV/°C
Output noise voltage	$f = 10\text{ Hz to }100\text{ kHz}$			40	200	μV
Dropout voltage				2		V
Bias current				4.5	6	mA
Bias current change	$I_O = 200\text{ mA}$, $V_I = 8\text{ V to }25\text{ V}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$				0.8	mA
	$I_O = 5\text{ mA to }350\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$				0.5	
Short-circuit output current	$V_I = 35\text{ V}$			300		mA
Peak output current				700		mA

(1) All characteristics are measured with a 0.33-μF capacitor across the input and a 0.1-μF capacitor across the output. Pulse-testing techniques maintain T_J as close to T_A as possible. Thermal effects must be taken into account separately.

(2) This specification applies only for dc power dissipation permitted by absolute maximum ratings

Electrical Characteristics

at specified virtual junction temperature, $V_I = 10\text{ V}$, $I_O = 350\text{ mA}$, $T_J = 25^\circ\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS ⁽¹⁾		μA78M05C			UNIT
			MIN	TYP	MAX	
Output voltage	$I_O = 5\text{ mA to }350\text{ mA}$, $V_I = 7\text{ V to }20\text{ V}$		4.8	5	5.2	V
		$T_J = 0^\circ\text{C to }125^\circ\text{C}$	4.75		5.25	
Input voltage regulation	$I_O = 200\text{ mA}$	$V_I = 7\text{ V to }25\text{ V}$		3	100	mV
		$V_I = 8\text{ V to }25\text{ V}$		1	50	
Ripple rejection	$V_I = 8\text{ V to }18\text{ V}$, $f = 120\text{ Hz}$	$I_O = 100\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$	62			dB
		$I_O = 300\text{ mA}$	62	80		
Output voltage regulation	$I_O = 5\text{ mA to }500\text{ mA}$			20	100	mV
	$I_O = 5\text{ mA to }200\text{ mA}$			10	50	
Temperature coefficient of output voltage	$I_O = 5\text{ mA}$	$T_J = 0^\circ\text{C to }125^\circ\text{C}$		–1		mV/°C
Output noise voltage	$f = 10\text{ Hz to }100\text{ kHz}$			40	200	μV
Dropout voltage				2		V
Bias current				4.5	6	mA
Bias current change	$I_O = 200\text{ mA}$, $V_I = 8\text{ V to }25\text{ V}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$				0.8	mA
	$I_O = 5\text{ mA to }350\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$				0.5	
Short-circuit output current	$V_I = 35\text{ V}$			300		mA
Peak output current				0.7		A

(1) All characteristics are measured with a 0.33-μF capacitor across the input and a 0.1-μF capacitor across the output. Pulse-testing techniques maintain T_J as close to T_A as possible. Thermal effects must be taken into account separately.

Electrical Characteristics

at specified virtual junction temperature, $V_I = 10\text{ V}$, $I_O = 350\text{ mA}$, $T_J = 25^\circ\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS ⁽¹⁾		μA78M051			UNIT
			MIN	TYP	MAX	
Output voltage	$I_O = 5\text{ mA to }350\text{ mA}$, $V_I = 7\text{ V to }20\text{ V}$		4.8	5	5.2	V
		$T_J = -40^\circ\text{C to }125^\circ\text{C}$	4.75		5.25	
Input voltage regulation	$I_O = 200\text{ mA}$	$V_I = 7\text{ V to }25\text{ V}$		3	100	mV
		$V_I = 8\text{ V to }25\text{ V}$		1	50	
Ripple rejection	$V_I = 8\text{ V to }18\text{ V}$, $f = 120\text{ Hz}$	$I_O = 100\text{ mA}$, $T_J = -40^\circ\text{C to }125^\circ\text{C}$	62			dB
		$I_O = 300\text{ mA}$	62	80		
Output voltage regulation	$I_O = 5\text{ mA to }500\text{ mA}$			20	100	mV
	$I_O = 5\text{ mA to }200\text{ mA}$			10	50	
Temperature coefficient of output voltage	$I_O = 5\text{ mA}$	$T_J = -40^\circ\text{C to }125^\circ\text{C}$		–1		mV/°C
Output noise voltage	$f = 10\text{ Hz to }100\text{ kHz}$			40	200	μV
Dropout voltage				2		V
Bias current				4.5	6	mA
Bias current change	$I_O = 200\text{ mA}$, $V_I = 8\text{ V to }25\text{ V}$, $T_J = -40^\circ\text{C to }125^\circ\text{C}$				0.8	mA
	$I_O = 5\text{ mA to }350\text{ mA}$, $T_J = -40^\circ\text{C to }125^\circ\text{C}$				0.5	
Short-circuit output current	$V_I = 35\text{ V}$			300		mA
Peak output current				0.7		A

(1) All characteristics are measured with a 0.33-μF capacitor across the input and a 0.1-μF capacitor across the output. Pulse-testing techniques maintain T_J as close to T_A as possible. Thermal effects must be taken into account separately.

Electrical Characteristics

at specified virtual junction temperature, $V_I = 11\text{ V}$, $I_O = 350\text{ mA}$, $T_J = 25^\circ\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS ⁽¹⁾		μA78M06C			UNIT
			MIN	TYP	MAX	
Output voltage	$I_O = 5\text{ mA to }350\text{ mA}$, $V_I = 8\text{ V to }21\text{ V}$		5.75	6	6.25	V
		$T_J = 0^\circ\text{C to }125^\circ\text{C}$	5.7		6.3	
Input voltage regulation	$I_O = 200\text{ mA}$	$V_I = 8\text{ V to }25\text{ V}$		5	100	mV
		$V_I = 9\text{ V to }25\text{ V}$		1.5	50	
Ripple rejection	$V_I = 8\text{ V to }18\text{ V}$, $f = 120\text{ Hz}$	$I_O = 100\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$	59			dB
		$I_O = 300\text{ mA}$	59	80		
Output voltage regulation	$I_O = 5\text{ mA to }500\text{ mA}$			20	120	mV
	$I_O = 5\text{ mA to }200\text{ mA}$			10	60	
Temperature coefficient of output voltage	$I_O = 5\text{ mA}$	$T_J = 0^\circ\text{C to }125^\circ\text{C}$		–1		mV/°C
Output noise voltage	$f = 10\text{ Hz to }100\text{ kHz}$			45		μV
Dropout voltage				2		V
Bias current				4.5	6	mA
Bias current change	$V_I = 9\text{ V to }25\text{ V}$, $I_O = 200\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$				0.8	mA
	$I_O = 5\text{ mA to }350\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$				0.5	
Short-circuit output current	$V_I = 35\text{ V}$			270		mA
Peak output current				0.7		A

(1) All characteristics are measured with a 0.33-μF capacitor across the input and a 0.1-μF capacitor across the output. Pulse-testing techniques maintain T_J as close to T_A as possible. Thermal effects must be taken into account separately.

Electrical Characteristics

at specified virtual junction temperature, $V_I = 14\text{ V}$, $I_O = 350\text{ mA}$, $T_J = 25^\circ\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS ⁽¹⁾		μA78M08C			UNIT
			MIN	TYP	MAX	
Output voltage	$V_I = 10.5\text{ V to }23\text{ V}$, $I_O = 5\text{ mA to }350\text{ mA}$		7.7	8	8.3	V
		$T_J = 0^\circ\text{C to }125^\circ\text{C}$	7.6		8.4	
Input voltage regulation	$I_O = 200\text{ mA}$	$V_I = 10.5\text{ V to }25\text{ V}$		6	100	mV
		$V_I = 11\text{ V to }25\text{ V}$		2	50	
Ripple rejection	$V_I = 11\text{ V to }21.5\text{ V}$, $f = 120\text{ Hz}$	$I_O = 100\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$	56			dB
		$I_O = 300\text{ mA}$	56	80		
Output voltage regulation	$I_O = 5\text{ mA to }500\text{ mA}$			25	160	mV
	$I_O = 5\text{ mA to }200\text{ mA}$			10	80	
Temperature coefficient of output voltage	$I_O = 5\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$			–1		mV/°C
Output noise voltage	$f = 10\text{ Hz to }100\text{ kHz}$			52		μV
Dropout voltage				2		V
Bias current				4.6	6	mA
Bias current change	$V_I = 10.5\text{ V to }25\text{ V}$, $I_O = 5\text{ mA to }350\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$	$I_O = 200\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$			0.8	mA
					0.5	
Short-circuit output current	$V_I = 35\text{ V}$			250		mA
Peak output current				0.7		A

(1) All characteristics are measured with a 0.33-μF capacitor across the input and a 0.1-μF capacitor across the output. Pulse-testing techniques maintain T_J as close to T_A as possible. Thermal effects must be taken into account separately.

Electrical Characteristics

at specified virtual junction temperature, $V_I = 16\text{ V}$, $I_O = 350\text{ mA}$, $T_J = 25^\circ\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS ⁽¹⁾		μA78M09C			UNIT
			MIN	TYP	MAX	
Output voltage	$V_I = 11.5\text{ V to }24\text{ V}$, $I_O = 5\text{ mA to }350\text{ mA}$		8.6	9	9.4	V
		$T_J = 0^\circ\text{C to }125^\circ\text{C}$	8.5		9.5	
Input voltage regulation	$I_O = 200\text{ mA}$	$V_I = 11.5\text{ V to }26\text{ V}$		6	100	mV
		$V_I = 12\text{ V to }26\text{ V}$		2	50	
Ripple rejection	$V_I = 13\text{ V to }23\text{ V}$, $f = 120\text{ Hz}$	$I_O = 100\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$	56			dB
		$I_O = 300\text{ mA}$	56	80		
Output voltage regulation	$I_O = 5\text{ mA to }500\text{ mA}$			25	180	mV
	$I_O = 5\text{ mA to }200\text{ mA}$			10	90	
Temperature coefficient of output voltage	$I_O = 5\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$			–1		mV/°C
Output noise voltage	$f = 10\text{ Hz to }100\text{ kHz}$			58		μV
Dropout voltage				2		V
Bias current				4.6	6	mA
Bias current change	$V_I = 11.5\text{ V to }26\text{ V}$, $I_O = 5\text{ mA to }350\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$	$I_O = 200\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$			0.8	mA
					0.5	
Short-circuit output current	$V_I = 35\text{ V}$			250		mA
Peak output current				0.7		A

(1) All characteristics are measured with a 0.33-μF capacitor across the input and a 0.1-μF capacitor across the output. Pulse-testing techniques maintain T_J as close to T_A as possible. Thermal effects must be taken into account separately.

Electrical Characteristics

at specified virtual junction temperature, $V_I = 17\text{ V}$, $I_O = 350\text{ mA}$, $T_J = 25^\circ\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS ⁽¹⁾		μA78M10C			UNIT
			MIN	TYP	MAX	
Output voltage	$V_I = 12.5\text{ V to }25\text{ V}$, $I_O = 5\text{ mA to }350\text{ mA}$		9.6	10	10.4	V
		$T_J = 0^\circ\text{C to }125^\circ\text{C}$	9.5		10.5	
Input voltage regulation	$I_O = 200\text{ mA}$	$V_I = 12.5\text{ V to }28\text{ V}$		7	100	mV
		$V_I = 14\text{ V to }28\text{ V}$		2	50	
Ripple rejection	$V_I = 15\text{ V to }25\text{ V}$, $f = 120\text{ Hz}$	$I_O = 100\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$	59			dB
		$I_O = 300\text{ mA}$	55	80		
Output voltage regulation	$I_O = 5\text{ mA to }500\text{ mA}$			25	200	mV
	$I_O = 5\text{ mA to }200\text{ mA}$			10	100	
Temperature coefficient of output voltage	$I_O = 5\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$			–1		mV/°C
Output noise voltage	$f = 10\text{ Hz to }100\text{ kHz}$			64		μV
Dropout voltage				2		V
Bias current				4.7	6	mA
Bias current change	$V_I = 12.5\text{ V to }28\text{ V}$, $I_O = 5\text{ mA to }350\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$	$I_O = 200\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$			0.8	mA
					0.5	
Short-circuit output current	$V_I = 35\text{ V}$			245		mA
Peak output current				0.7		A

(1) All characteristics are measured with a 0.33-μF capacitor across the input and a 0.1-μF capacitor across the output. Pulse-testing techniques maintain T_J as close to T_A as possible. Thermal effects must be taken into account separately.

Electrical Characteristics

at specified virtual junction temperature, $V_I = 19\text{ V}$, $I_O = 350\text{ mA}$, $T_J = 25^\circ\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS ⁽¹⁾		μA78M12C			UNIT
			MIN	TYP	MAX	
Output voltage	$V_I = 14.5\text{ V to }27\text{ V}$, $I_O = 5\text{ mA to }350\text{ mA}$		11.5	12	12.5	V
		$T_J = 0^\circ\text{C to }125^\circ\text{C}$	11.4		12.6	
Input voltage regulation	$I_O = 200\text{ mA}$	$V_I = 14.5\text{ V to }30\text{ V}$		8	100	mV
		$V_I = 16\text{ V to }30\text{ V}$		2	50	
Ripple rejection	$V_I = 15\text{ V to }25\text{ V}$, $f = 120\text{ Hz}$	$I_O = 100\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$	55			dB
		$I_O = 300\text{ mA}$	55	80		
Output voltage regulation	$I_O = 5\text{ mA to }500\text{ mA}$			25	240	mV
	$I_O = 5\text{ mA to }200\text{ mA}$			10	120	
Temperature coefficient of output voltage	$I_O = 5\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$			–1		mV/°C
Output noise voltage	$f = 10\text{ Hz to }100\text{ kHz}$			75		μV
Dropout voltage				2		V
Bias current				4.8	6	mA
Bias current change	$V_I = 14.5\text{ V to }30\text{ V}$, $I_O = 5\text{ mA to }350\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$	$I_O = 200\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$			0.8	mA
					0.5	
Short-circuit output current	$V_I = 35\text{ V}$			240		mA
Peak output current				0.7		A

(1) All characteristics are measured with a 0.33-μF capacitor across the input and a 0.1-μF capacitor across the output. Pulse-testing techniques maintain T_J as close to T_A as possible. Thermal effects must be taken into account separately.

The μA78M15 is obsolete and no longer supplied.

Electrical Characteristics

at specified virtual junction temperature, $V_I = 23\text{ V}$, $I_O = 350\text{ mA}$, $T_J = 25^\circ\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS ⁽¹⁾			μA78M15C			UNIT
				MIN	TYP	MAX	
Output voltage	$V_I = 17.5\text{ V to }30\text{ V}$, $I_O = 5\text{ mA to }350\text{ mA}$	$T_J = 0^\circ\text{C to }125^\circ\text{C}$		14.4	15	15.6	V
				14.25		15.75	
Input voltage regulation	$I_O = 200\text{ mA}$	$V_I = 17.5\text{ V to }30\text{ V}$			10	100	mV
		$V_I = 20\text{ V to }30\text{ V}$			3	50	
Ripple rejection	$V_I = 18.5\text{ V to }28.5\text{ V}$, $f = 120\text{ Hz}$	$I_O = 100\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$		54			dB
		$I_O = 300\text{ mA}$		54	70		
Output voltage regulation	$I_O = 5\text{ mA to }500\text{ mA}$				25	300	mV
	$I_O = 5\text{ mA to }200\text{ mA}$				10	150	
Temperature coefficient of output voltage	$I_O = 5\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$				–1		mV/°C
Output noise voltage	$f = 10\text{ Hz to }100\text{ kHz}$				90		μV
Dropout voltage					2		V
Bias current					4.8	6	mA
Bias current change	$V_I = 17.5\text{ V to }30\text{ V}$, $I_O = 5\text{ mA to }350\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$	$I_O = 200\text{ mA}$, $T_J = 0^\circ\text{C to }125^\circ\text{C}$				0.8	mA
						0.5	
Short-circuit output current	$V_I = 35\text{ V}$				240		mA
Peak output current					0.7		A

(1) All characteristics are measured with a 0.33-μF capacitor across the input and a 0.1-μF capacitor across the output. Pulse-testing techniques maintain T_J as close to T_A as possible. Thermal effects must be taken into account separately.

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
UA78M05CDCY	ACTIVE	SOT-223	DCY	4	80	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR
UA78M05CDCYG3	ACTIVE	SOT-223	DCY	4	80	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR
UA78M05CDCYR	ACTIVE	SOT-223	DCY	4	2500	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR
UA78M05CDCYRG3	ACTIVE	SOT-223	DCY	4	2500	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR
UA78M05CKC	NRND	TO-220	KC	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M05CKCS	ACTIVE	TO-220	KCS	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M05CKCSE3	ACTIVE	TO-220	KCS	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M05CKTPR	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M05CKTPRG3	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M05CKVURG3	ACTIVE	PFM	KVU	3	2500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR
UA78M05IDCY	ACTIVE	SOT-223	DCY	4	80	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR
UA78M05IDCYG3	ACTIVE	SOT-223	DCY	4	80	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR
UA78M05IDCYR	ACTIVE	SOT-223	DCY	4	2500	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR
UA78M05IDCYRG3	ACTIVE	SOT-223	DCY	4	2500	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR
UA78M05IKC	NRND	TO-220	KC	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M05IKCE3	NRND	TO-220	KC	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M05IKCS	ACTIVE	TO-220	KCS	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M05IKCSE3	ACTIVE	TO-220	KCS	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M05IKTPR	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M05IKTPRG3	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M05IKVURG3	ACTIVE	PFM	KVU	3	2500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR
UA78M06CKC	OBSOLETE	TO-220	KC	3		TBD	Call TI	Call TI
UA78M06CKTPR	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M06CKTPRG3	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M06CKVURG3	ACTIVE	PFM	KVU	3	2500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
UA78M08CDCY	ACTIVE	SOT-223	DCY	4	80	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR
UA78M08CDCYG3	ACTIVE	SOT-223	DCY	4	80	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR
UA78M08CDCYR	ACTIVE	SOT-223	DCY	4	2500	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR
UA78M08CDCYRG3	ACTIVE	SOT-223	DCY	4	2500	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR
UA78M08CKC	NRND	TO-220	KC	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M08CKCE3	NRND	TO-220	KC	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M08CKCS	ACTIVE	TO-220	KCS	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M08CKCSE3	ACTIVE	TO-220	KCS	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M08CKTPR	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M08CKTPRG3	NRND	PFM	KTP	2	3000	TBD	Call TI	Call TI
UA78M08CKVURG3	ACTIVE	PFM	KVU	3	2500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR
UA78M09CKC	OBSOLETE	TO-220	KC	3		TBD	Call TI	Call TI
UA78M09CKTP	OBSOLETE	PFM	KTP	2		TBD	Call TI	Call TI
UA78M09CKTPR	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M09CKTPRG3	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M09CKVURG3	ACTIVE	PFM	KVU	3	2500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR
UA78M10CKC	OBSOLETE	TO-220	KC	3		TBD	Call TI	Call TI
UA78M10CKTPR	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M10CKTPRG3	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M10CKVURG3	ACTIVE	PFM	KVU	3	2500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR
UA78M12CKC	NRND	TO-220	KC	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M12CKCS	ACTIVE	TO-220	KCS	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M12CKCSE3	ACTIVE	TO-220	KCS	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M12CKTPR	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M12CKTPRG3	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M12CKVURG3	ACTIVE	PFM	KVU	3	2500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR
UA78M33CDCY	ACTIVE	SOT-223	DCY	4	80	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR
UA78M33CDCYG3	ACTIVE	SOT-223	DCY	4	80	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
no Sb/Br)								
UA78M33CDCYR	ACTIVE	SOT-223	DCY	4	2500	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR
UA78M33CDCYRG3	ACTIVE	SOT-223	DCY	4	2500	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR
UA78M33CKC	NRND	TO-220	KC	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M33CKCE3	NRND	TO-220	KC	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M33CKCS	ACTIVE	TO-220	KCS	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M33CKCSE3	ACTIVE	TO-220	KCS	3	50	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
UA78M33CKTPR	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M33CKTPRG3	NRND	PFM	KTP	2	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM
UA78M33CKVURG3	ACTIVE	PFM	KVU	3	2500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

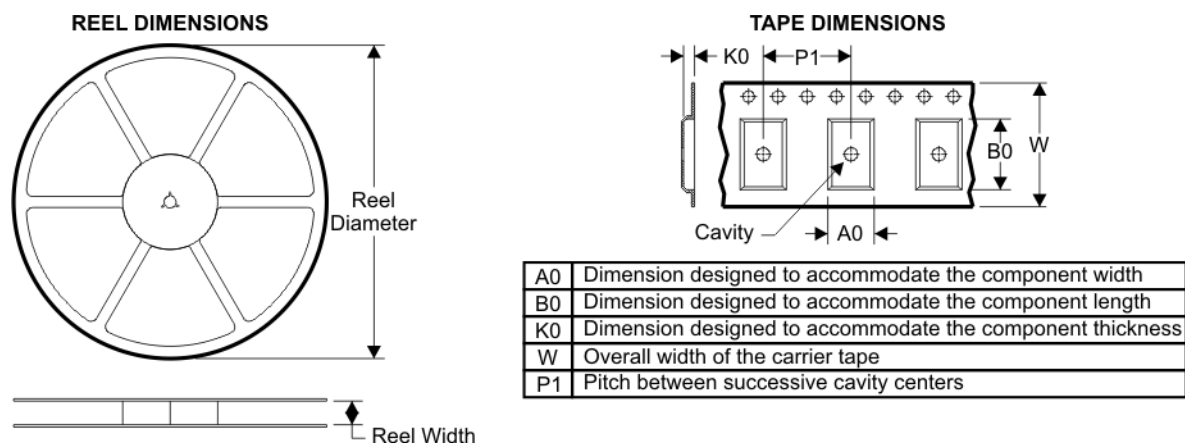
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

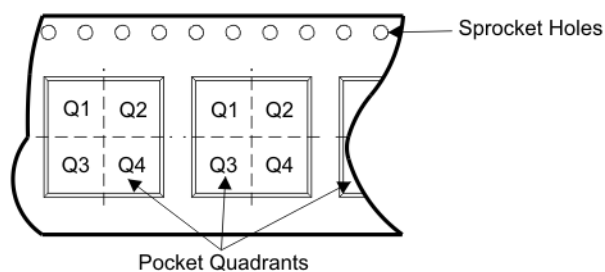
Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

TAPE AND REEL BOX INFORMATION

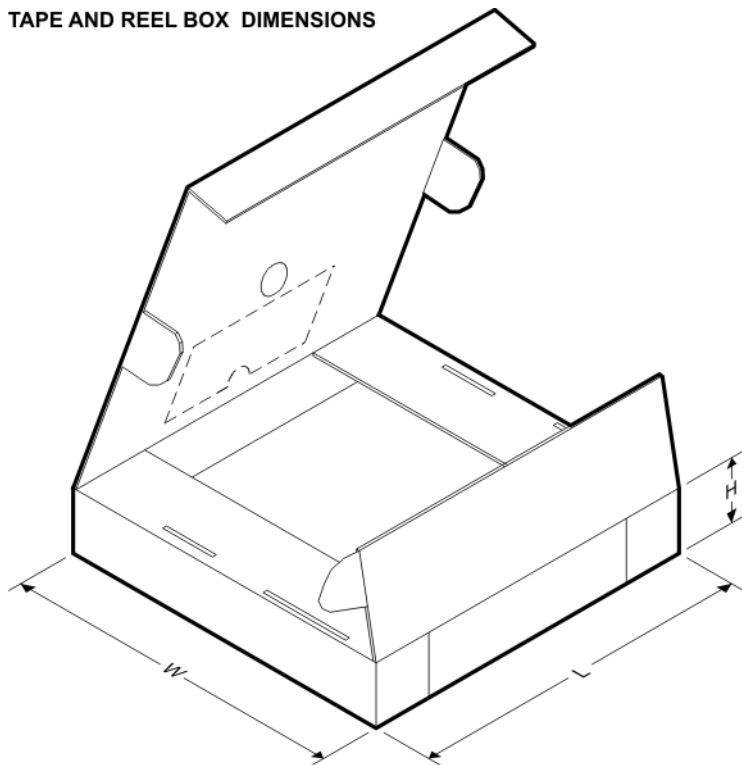


QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



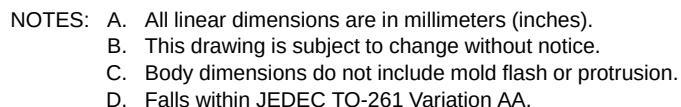
Device	Package	Pins	Site	Reel Diameter (mm)	Reel Width (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
UA78M05CKVURG3	KVU	3	SITE 45	330	16	6.9	10.5	2.7	8	16	Q2
UA78M05IKVURG3	KVU	3	SITE 45	330	16	6.9	10.5	2.7	8	16	Q2
UA78M06CKVURG3	KVU	3	SITE 45	330	16	6.9	10.5	2.7	8	16	Q2
UA78M08CKVURG3	KVU	3	SITE 45	330	16	6.9	10.5	2.7	8	16	Q2
UA78M09CKVURG3	KVU	3	SITE 45	330	16	6.9	10.5	2.7	8	16	Q2
UA78M10CKVURG3	KVU	3	SITE 45	330	16	6.9	10.5	2.7	8	16	Q2
UA78M12CKVURG3	KVU	3	SITE 45	330	16	6.9	10.5	2.7	8	16	Q2
UA78M33CKVURG3	KVU	3	SITE 45	330	16	6.9	10.5	2.7	8	16	Q2

TAPE AND REEL BOX DIMENSIONS



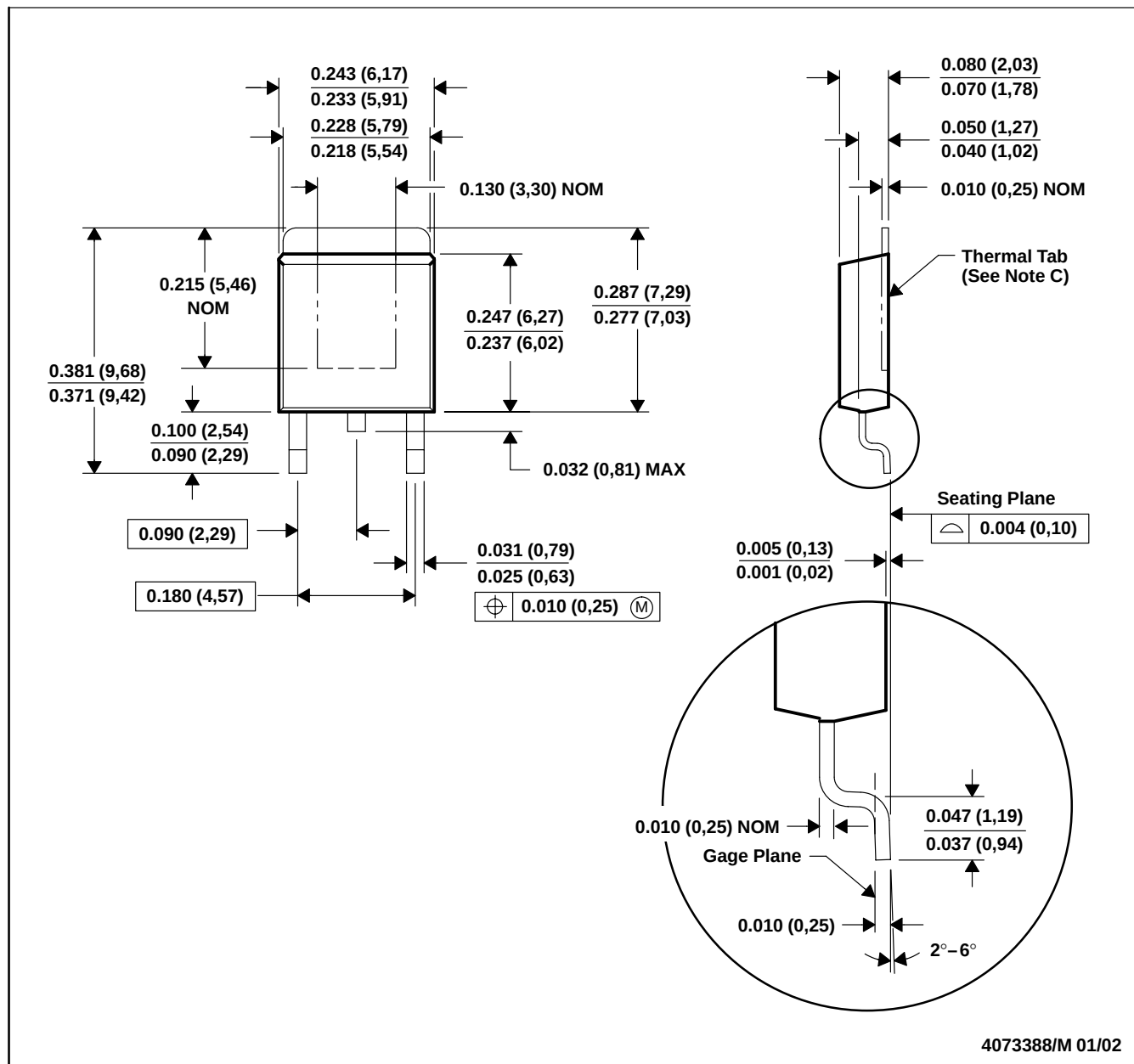
Device	Package	Pins	Site	Length (mm)	Width (mm)	Height (mm)
UA78M05CKVURG3	KVU	3	SITE 45	340.0	340.0	38.0
UA78M05IKVURG3	KVU	3	SITE 45	340.0	340.0	38.0
UA78M06CKVURG3	KVU	3	SITE 45	340.0	340.0	38.0
UA78M08CKVURG3	KVU	3	SITE 45	340.0	340.0	38.0
UA78M09CKVURG3	KVU	3	SITE 45	340.0	340.0	38.0
UA78M10CKVURG3	KVU	3	SITE 45	340.0	340.0	38.0
UA78M12CKVURG3	KVU	3	SITE 45	340.0	340.0	38.0
UA78M33CKVURG3	KVU	3	SITE 45	340.0	340.0	38.0

PLASTIC SMALL-OUTLINE



KTP (R-PSFM-G2)

PowerFLEX™ PLASTIC FLANGE-MOUNT PACKAGE

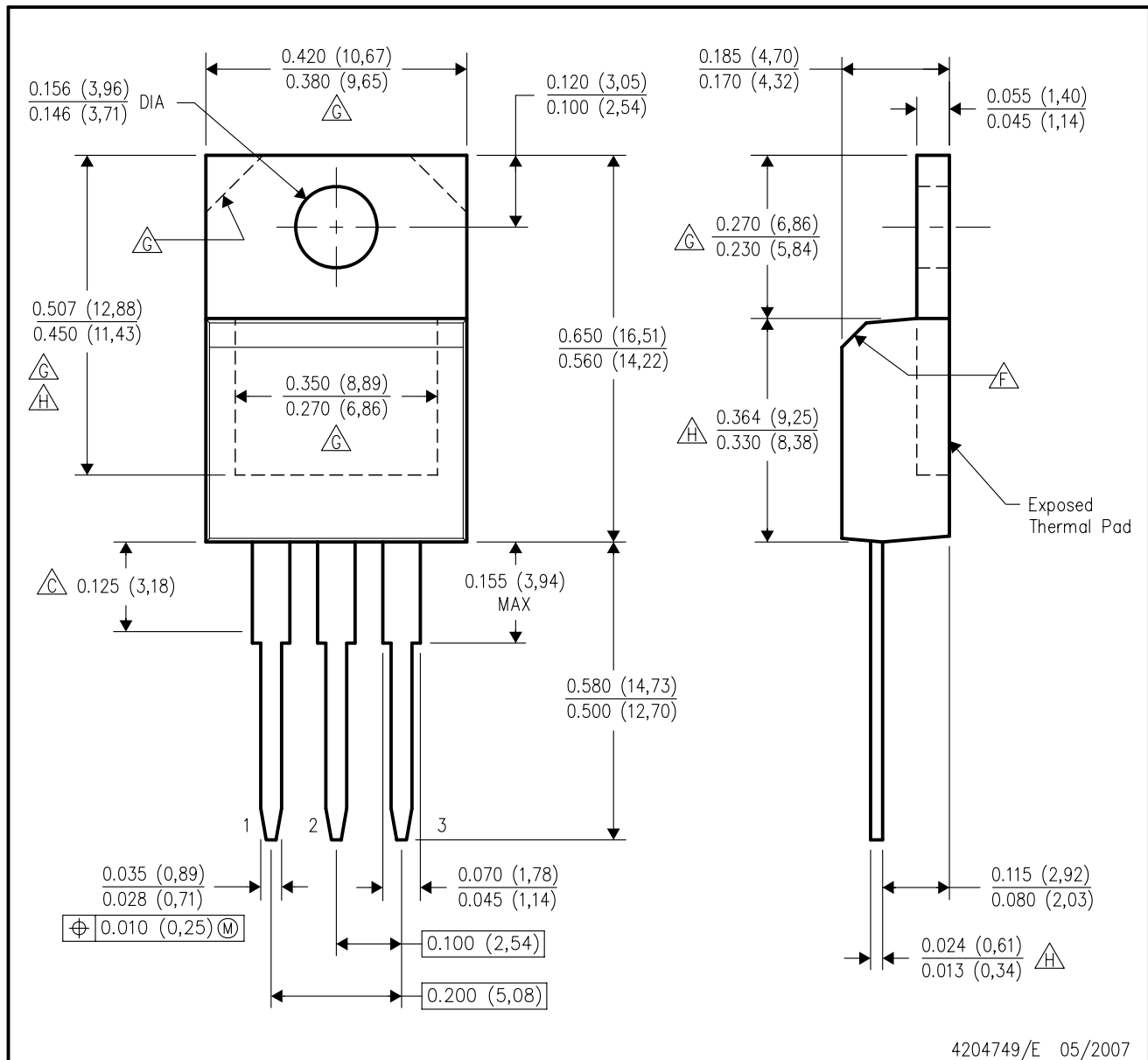


- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - The center lead is in electrical contact with the thermal tab.
 - Dimensions do not include mold protrusions, not to exceed 0.006 (0,15).
 - Falls within JEDEC TO-252 variation AC.

PowerFLEX is a trademark of Texas Instruments.

KCS (R-PSFM-T3)

PLASTIC FLANGE-MOUNT PACKAGE



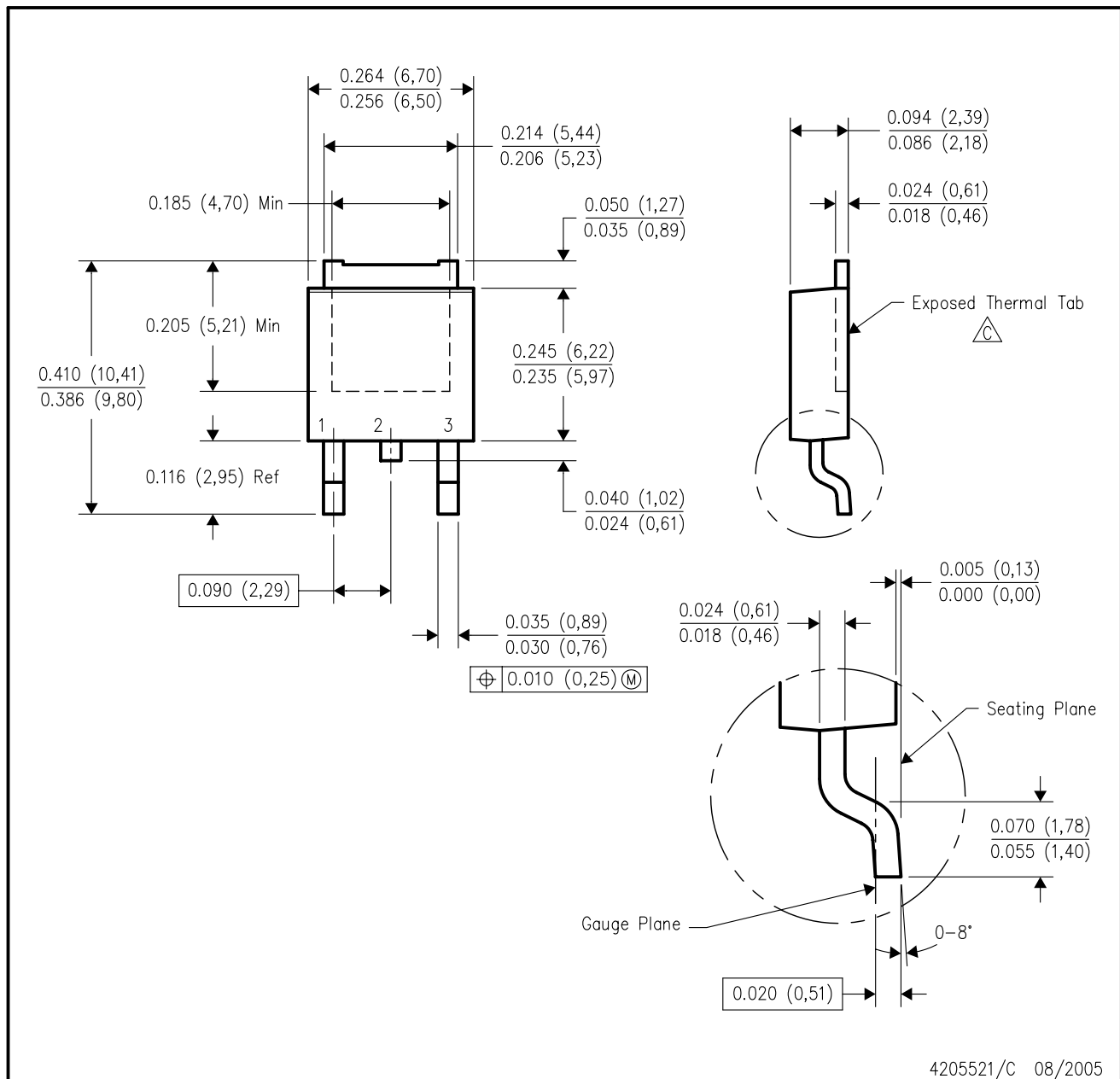
4204749/E 05/2007

NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Lead dimensions are not controlled within this area.
- D. All lead dimensions apply before solder dip.
- E. The center lead is in electrical contact with the mounting tab.
- F. The chamfer is optional.
- G. Thermal pad contour optional within these dimensions.
- H. Falls within JEDEC TO-220 variation AB, except minimum lead thickness, minimum exposed pad length, and maximum body length.

KVU (R-PSFM-G3)

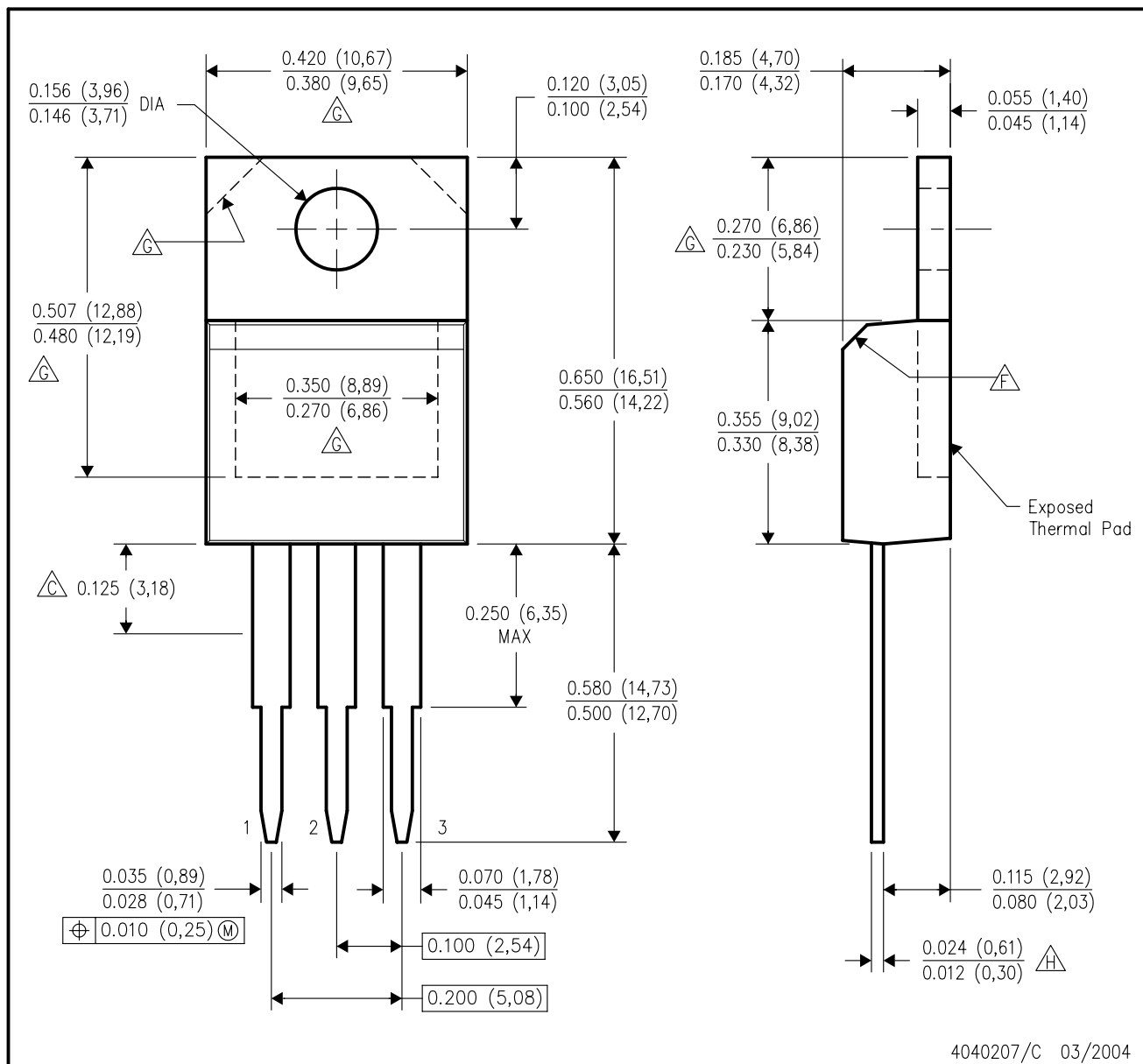
PLASTIC FLANGE-MOUNT PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. The center lead is in electrical contact with the exposed thermal tab.
 - D. Body Dimensions do not include mold flash or protrusions. Mold flash and protrusion shall not exceed 0.006 (0,15) per side.
 - E. Falls within JEDEC TO-252 variation AA.

KC (R-PSFM-T3)

PLASTIC FLANGE-MOUNT PACKAGE



4040207/C 03/2004

NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Lead dimensions are not controlled within this area.
- D. All lead dimensions apply before solder dip.
- E. The center lead is in electrical contact with the mounting tab.
- F. The chamfer is optional.
- G. Thermal pad contour optional within these dimensions.
- H. Falls within JEDEC TO-220 variation AB, except minimum lead thickness.

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products

Amplifiers	amplifier.ti.com
Data Converters	dataconverter.ti.com
DSP	dsp.ti.com
Clocks and Timers	www.ti.com/clocks
Interface	interface.ti.com
Logic	logic.ti.com
Power Mgmt	power.ti.com
Microcontrollers	microcontroller.ti.com
RFID	www.ti-rfid.com
RF/IF and ZigBee® Solutions	www.ti.com/lprf

Applications

Audio	www.ti.com/audio
Automotive	www.ti.com/automotive
Broadband	www.ti.com/broadband
Digital Control	www.ti.com/digitalcontrol
Medical	www.ti.com/medical
Military	www.ti.com/military
Optical Networking	www.ti.com/opticalnetwork
Security	www.ti.com/security
Telephony	www.ti.com/telephony
Video & Imaging	www.ti.com/video
Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright 2008, Texas Instruments Incorporated



О компании

ООО "ТрейдЭлектроникс" - это оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов. Реализуемая нашей компанией продукция насчитывает более полумиллиона наименований.

Благодаря этому наша компания предлагает к поставке практически не ограниченный ассортимент компонентов как оптовыми, мелкооптовыми партиями, так и в розницу.

Наличие собственной эффективной системы логистики обеспечивает надежную поставку продукции по конкурентным ценам в точно указанные сроки.

Срок поставки со стоков в **Европе и Америке – от 3 до 14 дней.**

Срок поставки из **Азии – от 10 дней.**

Благодаря развитой сети поставщиков, помогаем в поиске и приобретении экзотичных или снятых с производства компонентов.

Предоставляем спец цены на элементы для создания инженерных сэмплов.

Упорный труд, качественный результат дают нам право быть уверенными в себе и надежными для наших клиентов.

Наша компания это:

- Гарантия качества поставляемой продукции
- Широкий ассортимент
- Минимальные сроки поставок
- Техническая поддержка
- Подбор комплектации
- Индивидуальный подход
- Гибкое ценообразование

Наша организация особенно сильна в поставках модулей, микросхем, пассивных компонентов, ксайленсах (XC), EPF, EPM и силовой электроники.

Большой выбор предлагаемой продукции, различные виды оплаты и доставки, позволят Вам сэкономить время и получить максимум выгоды от сотрудничества с нами!

Перечень производителей, продукцию которых мы поставляем на российский рынок





Trade Electronics.ru

гарантия бесперебойности производства и
качества выпускаемой продукции

С удовольствием будем прорабатывать для Вас поставки всех необходимых компонентов по текущим запросам для скорейшего выявления групп элементов, по которым сотрудничество именно с нашей компанией будет для Вас максимально выгодным!

С уважением,

Менеджер отдела продаж ООО

«Трейд Электроникс»

Шишлаков Евгений

8 (495)668-30-28 доб 169

manager28@tradeelectronics.ru

<http://www.tradeelectronics.ru/>